4BIT SINGLE CHIP MICROCOMPUTER

The IN5732 is a CMOS 4-bit single chip microcomputer that operate on low voltage, very low current and contain LCD drivers. They also contain a 4 bit parallel processing ALU, a program memory ROM, many LCD segment outputs, a prescaler, an oscillator. The IN5732 is especially suited for use in high-grade timepieces, time controllers, electronic calculators, LCD games with timepiece. The IN5732 is especially suited for use in audio equipment, copiers, facsimiles with LCD and sub CPU applications.

FEATURES						
Supply voltage	1.5V or 3V (Mask option-selectable)					
Current dissipation	3.0 uA Typ. (Ag Battery version, 32KHz crystal oscillation, during timekeeping operation) 1.5 uA Typ. (Li Battery version, 32KHz crystal oscillation, during timekeeping operation)					
Oscillation Output pins for LCD drive	Crystal oscilla 27 pins	tion for timekee	ping (32.768 KHz); or CR oscillator.			
	Drivable LCD 1/2 bias 1/2 bias Static	panel 1/3 duty 1/2 duty	Number of Drivable LCD segment 81 segments 54 segments 27 segments			
On chip melody function Number of input pins	3 octaves (the melody length is solfware-controlled. One Musical note requires one byte.) 8					
Number of out pins	3 pins (Output dedicated to alarm: 2 pins, general-purpose output: 1 pin).					
Possible to use LCE selectable)	Possible to use LCD panel drive output pins as output pin-only ports (Mask option-					
ROM RAM	2048 X 8 bits 48 X 4 bits					
Cycle Time	CR oscillation 32.768 KHz c		60us 122us			
On chip step-up / ste Instruction set Table read instruction 1 level subroutine ne every 64ms/500ms v HALT function	92 instructions	s 15 bit divider for	timekeeping (delivers an overflow single used).			



IN5732

ABSOLUTE MAXIMUM RATINGS at Ta=25 ,V_{DD}=0V

	-		1	
Parameter	Sign.	Pins and Conditions	Value	Unit
Maximum Supply Voltage	V _{SS1}		-4.0 to +0.3 -4.0	V
	V _{SS2}		to +0.3	
Maximum Input Voltage	V _{IN}	S1-4, M1-4, 32Hz, TEST, 10P,	V _{SS1} -0.3 to +0.3	V
		OSCIN, RES		
Maximum Ouptut Voltage	V _{OUT1}	32Hz, CUP2, OSCOUT, ALM1,	V _{SS1} -0.3 to +0.3	V
		ALM2, LIGHT		
	V _{OUT2}	SEGOUT, COM1, COM2, COM3,	V _{SS2} -0.3 to +0.3	V
		CUP1		
Operating Temperature	Topg		-10 to +65	°C
Storage Temperature	Tstg		-30 to +125	°C

ALLOWABLE OPERATING CONDITIONS at Ta=25 + 2°C, V_{DD}=OV

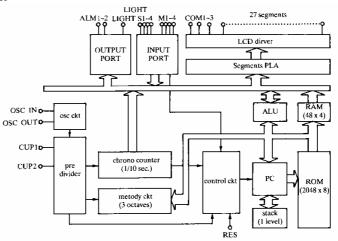
Parameter	Sign.	Pins and Conditions	min	typ	max	Unit
Supply Voltage	V _{SS1}		-1.65		-1.30	V
	V _{SS2}		-3.3		-2.4	V
Input 'H'-Level Voltage	VIH	S1-4,M1-4, RES	-0.2		0	V
Input 'L'-Level Voltage	VIL	S1-4, M1-4, RES	V _{SS1}		V _{SS1} +0	V
					.2	
Operating Frequency	fopgl	Ta=-10 to + 65 °C, crystal	32	32.	33	kHz
	fopg2	OSC		768		kHz
		Ta=-10 to + 65 °C, CR OSC				

ELECTRICAL CHARACTERISTICS at Ta=25 +-0.2°C V_{DD}=0V

Parameter	Sign.	Pins and Conditions	min	typ	max	Unit
Input Resistance	R _{INIA}	V_{SS1} =-1.55V, V_{IL} = V_{SS1} +0.2V,	200		2000	kΩ
		'L'level hold tr, *1				
	R _{INIB}	V _{SS1} =-1.55V,	200		2000	kΩ
		'L'level pull-in tr, *1				
	R _{IN2}	V _{SS1} =-1.55V, TEST, RES	10		300	kΩ
Output 'H'-Level Voltage	V _{OH1}	V _{SS1} =-1.55V, I _{OH} =-0.4uA, *2	-0.2			V
Output 'L'-Level Voltage	V _{OL1}	V _{SS1} =-1.55V, I _{OL} =0.4uA, *2			V _{SS2} +0.2	V
Output 'H'-Level Voltage	V _{OH2}	V _{SS1} =-1.55V, I _{OH} =-4uA,	-0.2			V
		COM1,COM2, COM3				
Output 'H'-Level Voltage	V _{OH3}	V _{SS1} =-1.35V, I _{OH} =-250uA,	-0.65		-1.30	V
		ALM1, ALM2, LIGHT				
Oscillation Start Time	t _{sT}	C _O =C _G =20pF, crystal OSC			10	sec
		(Cl≤25kΩ)				
Oscillation Compensation	10P	External pin	8	10	12	pF
Capacitance		-				-



BLOCK DIAGRAM

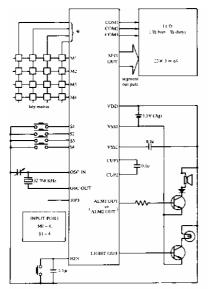


PIN DESCRIPTION

	in Nama		
II No	in Name	Input/Output	Function
No.			
33 (OSCIN	Input	Crystal OSC mode 32.768kHz crystal is connected across OSCIN and OSCOUT
			for oscillation. Used as reference clock for timepiece and system clock. CR OSC mode
35 O	SCOUT	Output	R and C are connected across OSCIN and OSCOUT for oscillation. Used as system clock.
34	10P		Connected to OSCOUT and used as OSC phase compensation capacitor.
31	S1	Input	
30	S2	•	Input-only port. LSI system is reset by applying V" to SI to S4 simultaneously.
3	S3		
2	S4		
4	MI	Input	
5	M2	-	
6	M3		Input pins for placing data in RAM.
7	M4		
32	RES	Input	Input pin for resetting LSI system.
57	BAK		(-) power supply pin for logic unit inside the LSI. For Li battery version, a
			capacitor must be connected across BAK and V" to prevent logic unit from malfunctionin .
52	LIGHT	Output	Output-only pin Suited for delivering signal to drive transistor for light.
53	ALM1	Output	Output-only pin Used to deliver *4kHz, 2kHz, 1kHz modulation signal with
54	ALM2	·	instruction. Also used to deliver non-modulation signal. Used to deliver melody signal of 3 octaves with instruction.
1	V _{DD}		(+) power supply pin.
55 V 56	$V_{\rm SS2} V_{\rm SS1}$		(-) power supply pin. Ag battery version, Li battery version, EXT-V version: mask option selectable. Also used as power supply for LCD drive.
	CUP1		Pins for connecting voltage step-up (step-down) capacitor.
	CUP2		
	COM1	Output	
	COM2		Output pins for LCD panel common plate.
	COM3		
19 - 23		Output	Segment driver
38 - 50		Output	Output pins for LCD panel segments. Mask option permits Seg 14 to Seg 27 (pad No.10 to 23)to be used as output ports.
27	32Hz	Test	
36	Т3		Test pins (not used by user)
26	TEST		
8	TEST		
9	TEST		

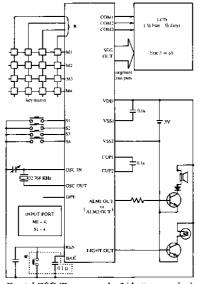
SAMPLE APPLICATION CIRCUITS

(1) Ag battery used application (1/2 bias 1/3 duty): *4 segment outputs are used for output ports.



Crystal OSC (Power supply: Ag battery version)

(2) Li battery used application or EXT-V Used application (1/2 bias 1/3 duty): * 4 segment outputs are used for output ports.



Crystal OSC (Power supply: Li battery version) # Components inside the dot line can be disconnected for EXT- V application.

